

**Dynamic (on demand) variation  
of liquid phase flow of (any)  
evaporative coolant in new systems**

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Thermosyphon workshop, CERN, July 6, 2009

# Advantages of dynamic flow variation

- ❖ **Delivers only as much liquid as is instantaneously needed;**  
*does not need to know the instantaneous demand from the silicon detector cooling circuit – works to eliminate unevaporated liquid in the exhaust (though this can also be made available if desired)*
- ❖ **Eliminates the need for a heater in the exhaust to vaporize any remaining liquid;**  
*(in the present system heaters are required to operate reliably in any orientation in stratified liquid-vapor and biphasic coolant mixtures)*
- ❖ **Coupled with cold delivery using precooling from *separate* circuits operating the same coolant, enthalpy can be maximized without a local (*ID volume*) heat exchanger per circuit as at present;**
- ❖ **Not based on particularly new principles;**  
*replaces the on-evaporator vapour pressure bulb flow control system with an electronic system for an environment where VPB's cannot be installed*

# PRE-HISTORY...

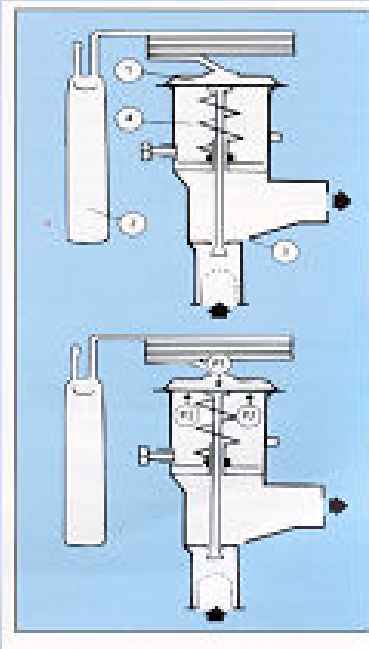
From conceptual design of pixel services workshop: Dec 7, 2001

## Comparison with Industrial Practice

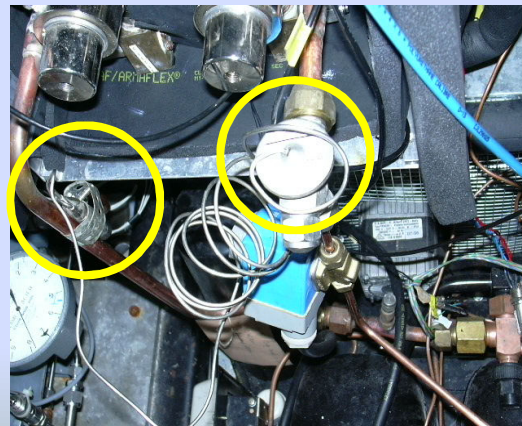
Industrial refrigeration, thermostatic valves regulate coolant mass flow.

**HOWEVER**, valve is the only detent, and is mounted directly on the evaporator

(1) Valve body with membrane and connected stem tip



(2) Injectors of varying sizes, variable over certain pressure range by pressure on stem tip (1)



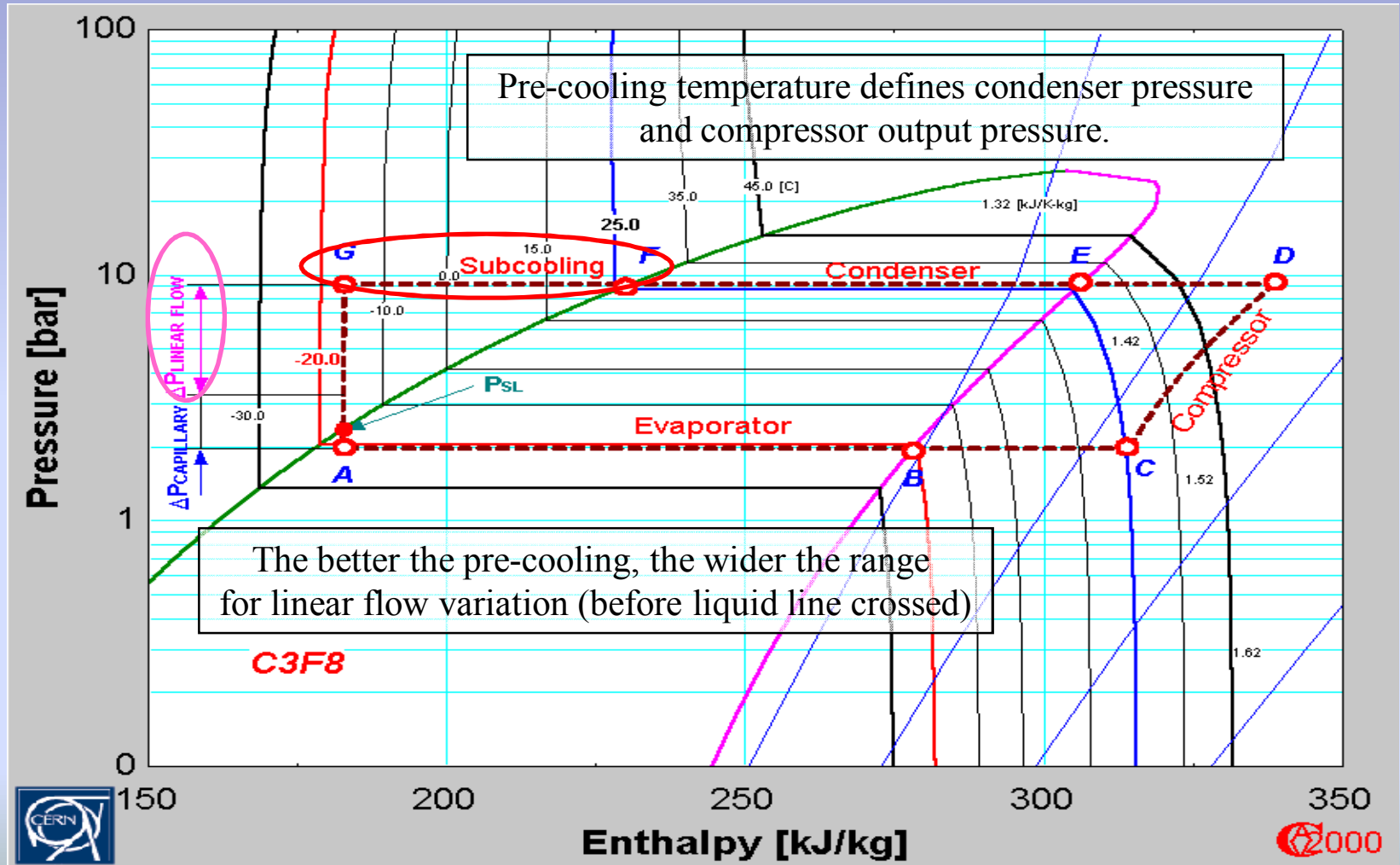
(3) Vapour pressure bulb containing same process fluid as cooling circuit, clamped to evaporator exhaust tube and acting on stem tip (1) to vary flow rate, avoiding unevaporated liquid in downstream tubing

**In our application, radiation length concerns preclude the placement of vapour pressure bulbs (VPBs) and dome loaded throttle valves on the evaporators (SCT & pixel structures): capillaries also preferred for innermost delivery tubes**

**Simply moving VPBs and throttle valves to the service platforms does not help: the entire supply and return tubing through the magnet would be redefined as the evaporator and would operate at  $-27^{\circ}\text{C}$  in the present system**

**Correct solution is to use a dome-loaded pressure regulator on the service platforms and a low mass measurement of post-evaporator temperature (PT100, NTC thermistor etc) with combined electro-pneumatic feedback to pressure regulator. This was demonstrated in 2000 but not taken up.**

# $C_3F_8$ Cycle indicating the wide variation of flow possible in combination with optimized pre-cooling

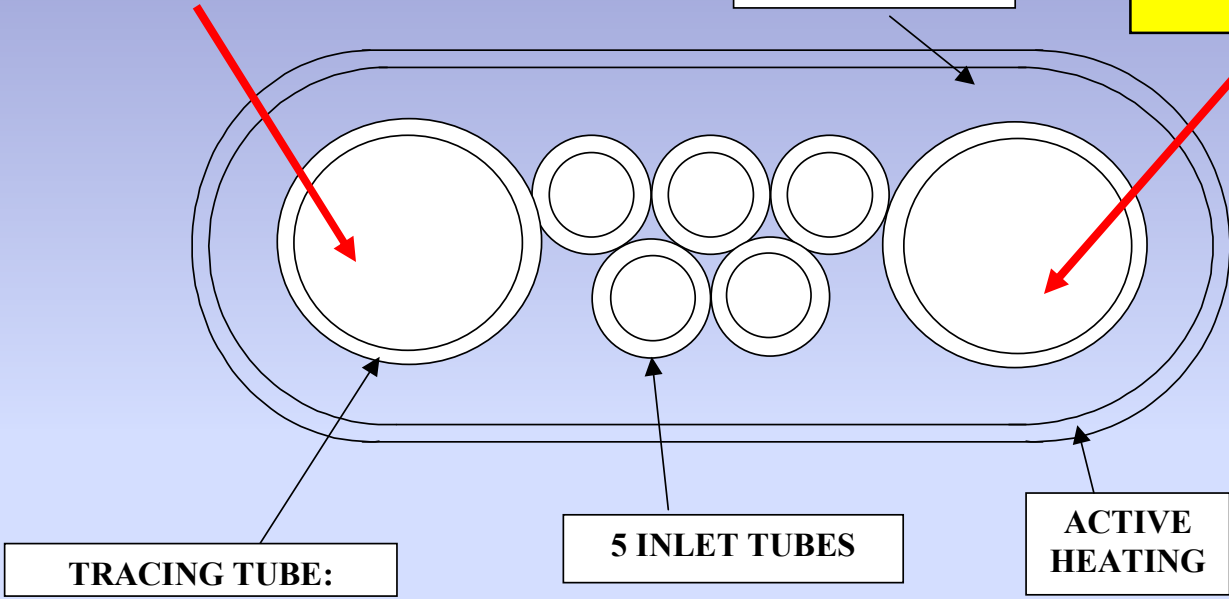


**Example of liquid supply multi - tube bundle sized for passing through ATLAS magnet to ID volume (Andy Nichols, RAL, 2000-2001)**

**Precooling Supply Tube:**

**INSULATION**

**Precooling Return Tube:  
Loop-back**

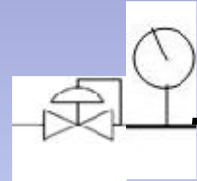


**TRACING TUBE:**

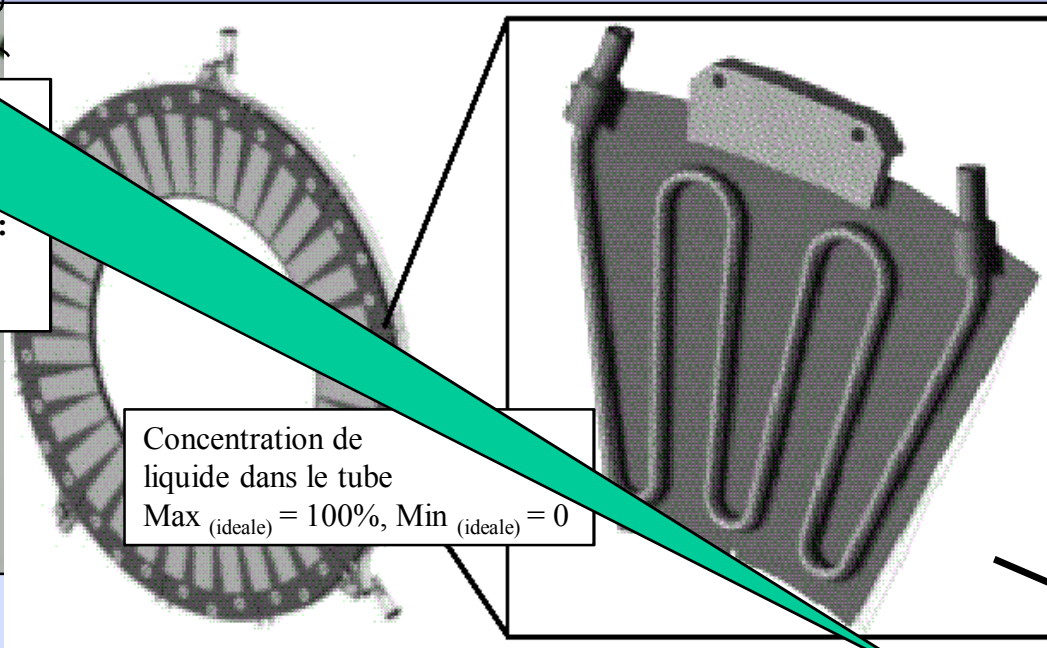
**5 INLET TUBES**

**ACTIVE HEATING**

# Principe « on-detector » de refroidissement (toutes fluides)

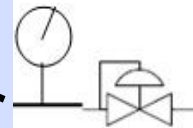


Dispositif de livraison liquide  
Réglage de débit par détendeur  
amont d'une restriction  
(qui provoque l'expansion J-T:  
**capillaire sert aussi comme  
tube fin de livraison liquide**)



Concentration de  
liquide dans le tube  
 $\text{Max}_{(ideale)} = 100\%$ ,  $\text{Min}_{(ideale)} = 0$

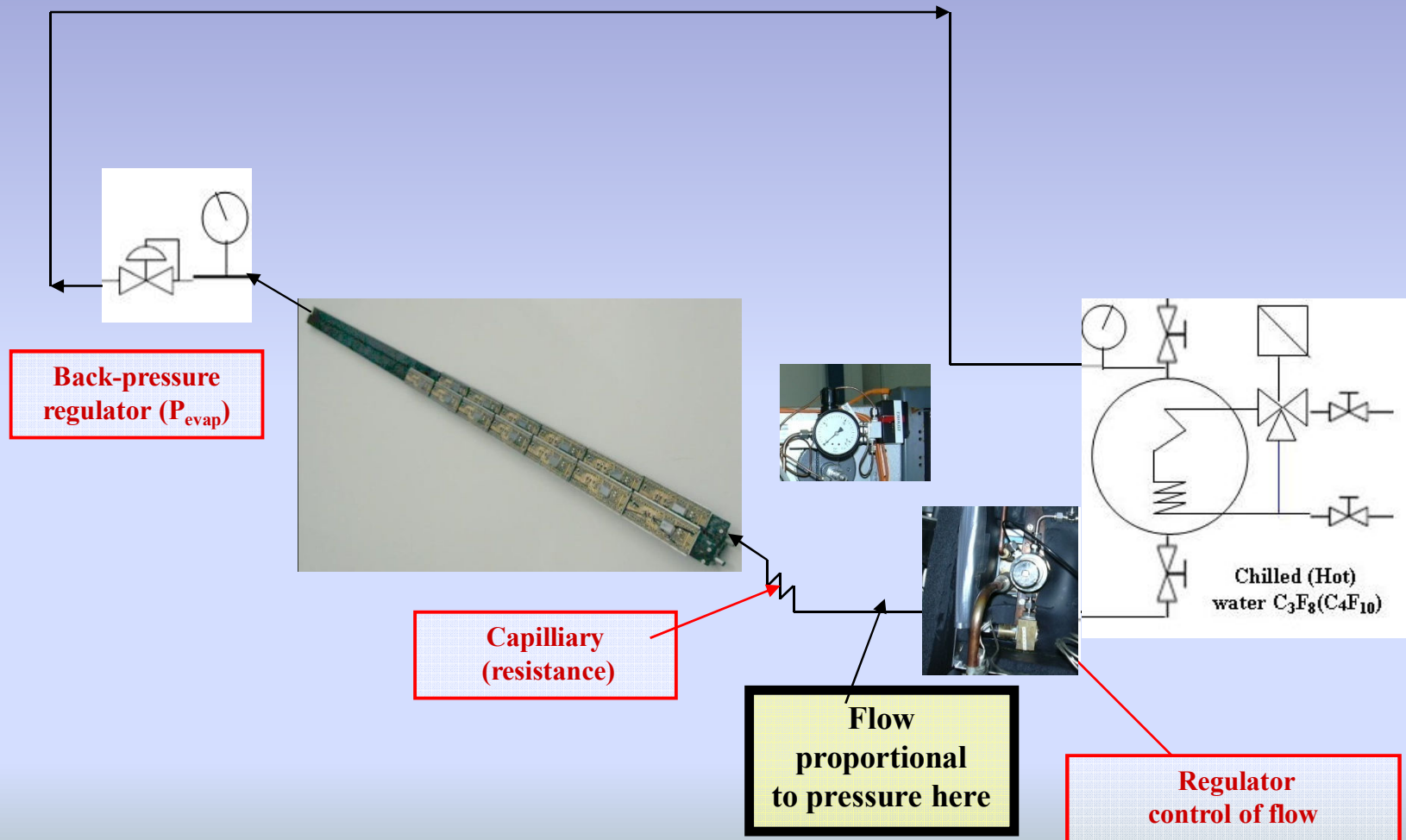
Dispositif de réglage  
de la température  
moyenne de fluide  
dans la structure à refroidir



**Déverseur/  
Back-pressure  
regulator pour  
chaque circuit  
( $P_{evap}$  individuelle)**

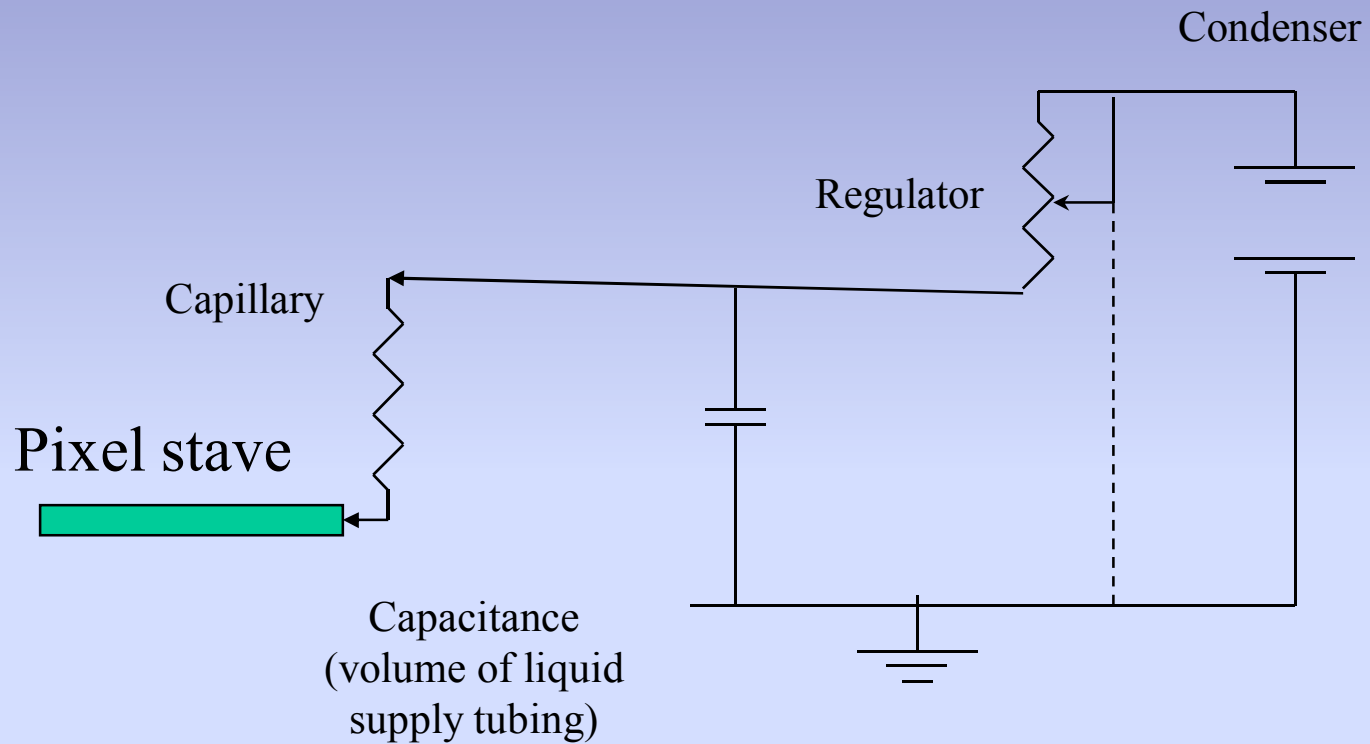


# Flow variation (flow regulator) for variable thermal load on a pixel stave





## Equivalent electric circuit



Discharge of capacitance through capillary

## Ce qui a été implémenté par ATLAS (2)

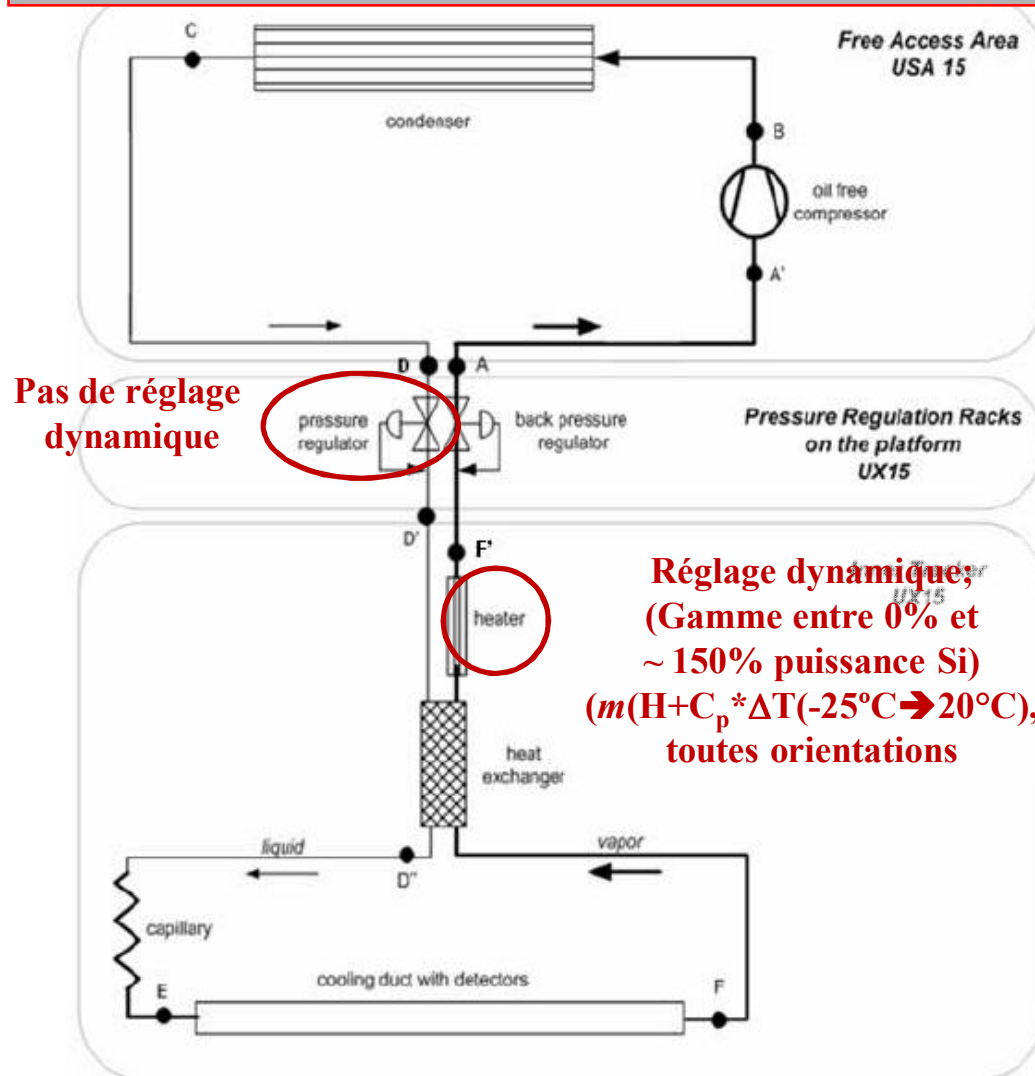


Figure 3. Schematic diagram of the evaporative system.

## Development of Fluorocarbon Evaporative Cooling Recirculators and Controls

for the ATLAS Pixel and Semiconductor Tracking Detectors.

Bayer, C.<sup>1</sup>, Berry, S.<sup>2</sup>, Bonneau, P.<sup>2</sup>, Bosteels, M.<sup>2</sup>, Burckhart, H.<sup>2</sup>, Cragg, D.<sup>3</sup>, English, R.<sup>3</sup>, Hallowell, G.<sup>3,4\*</sup>, Hallgren, B.<sup>2</sup>, Kersten, S.<sup>1</sup>, Kind, P.<sup>1</sup>, Langedrag, K.<sup>5</sup>, Lindsay, S.<sup>6</sup>, Merkel, M.<sup>2</sup>, Stappnes, S.<sup>5</sup>, Thadome, J.<sup>1</sup>, Vacek, V.<sup>2,7</sup>

<sup>1</sup> Physics Department, Wuppertal University, Germany; <sup>2</sup> CERN, 1211 Geneva 23, Switzerland;

<sup>3</sup> Rutherford Appleton Laboratory, Chilton, Didcot, OX110QX, UK;

<sup>4</sup> Centre de Physique des Particules de Marseille, Campus des Sciences de Luminy, 13288 Marseille, France;

# Proc 6th Workshop on Electronics for LHC Experiments, Crackow, Poland, September 2000 CERN 2000-101 CERN/LHCC/2000-041, 25 Oct 2000

We fluor system Tracking A with

pressure in each circuit is individually tuned via feedback according to the load variation, using analog air pressure proportional relays. A hard-wired thermal interlock system fully cuts power to individual silicon modules if the temperature exceed setpoint values.

All elements have been implemented in a standard Board ("") DAQ and DAQ administered through Prototype 16 channel interface.

Highly satisfactory results were seen with proportional power. Future developments

The 40000 beam pipe will be evaporative cooled via PID variation from zero to 100% power. Future developments

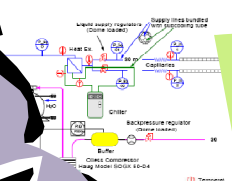
beam pipe will be evaporative cooled via PID variation from zero to 100% power. Future developments

beam pipe will be evaporative cooled via PID variation from zero to 100% power. Future developments

## II. APPARATUS AND PRINCIPLES

The prototype circulator Figure 1 is centred around an oil-less piston compressor<sup>2</sup> operating at a nominal pressure of ~ 1 bar<sub>abs</sub> and an output pressure of ~ 2.5 bar<sub>abs</sub>.

Prototype Circulator and Control System



temperature distribution on powered silicon modules under steady state, partial-load, interlock-trip, start-up and shutdown conditions using two methods of proportional fluid control.

### 2.1) I-Box Bit Counting.

In the first, the number of powered modules was counted via I-Box bits asserted, and the flow varied according to a protocol:

$$Q = m^{\#} / (\# \text{powered modules}) \quad (1)$$

where  $Q$  is the WAGO DAC output acting on the dome loaded with a certain amount of proportionality in order to drive sufficient flow through the capillary to evacuate the CT module (~ 10 Watts max).

Analysing heat transfer curves were taken downstream of the evaporator. The results indicated that the flow control was effective in reducing the variations in temperature of the un-powered modules toward the evaporation (tube) temperature is seen, while the powered modules remain roughly constant in temperature. In setting up the PID parameters, care was needed to ensure that the lower pressure limit was not less than  $P_{SL}$  during evaporation or PID auto-tuning.

The results indicated that with proportional flow control, uniformity in the temperature of powered modules was achieved. This protocol requires (i) DCS access to the monitored voltages and currents on several supply rails per module, and (ii) that the power supplies continue to supply this information.

## IV. EXPERIMENTAL RESULTS FROM THE PRESENT STUDY

### 1) Studies of Heater Interlock Hysteresis

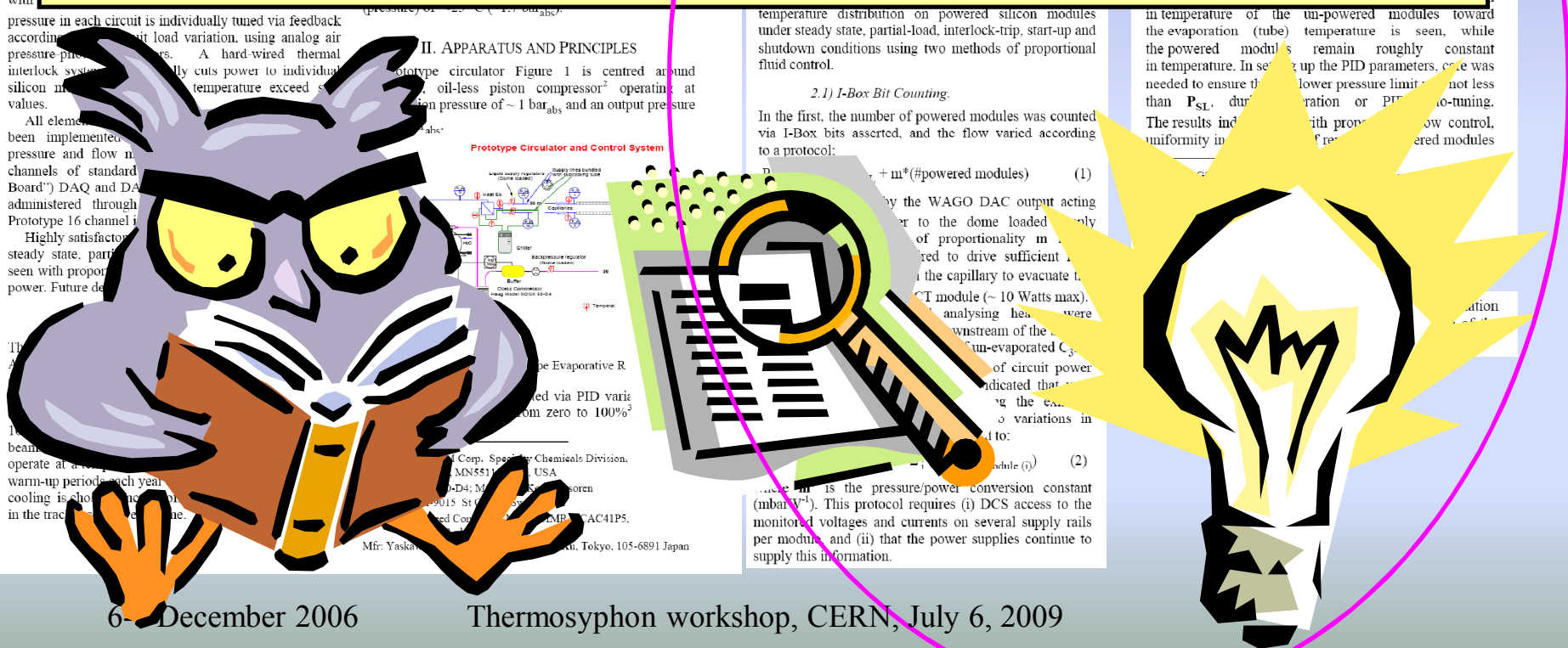
To reduce the influence of noise, the comparator circuits of the I-Box are equipped with hysteresis. The hard-wired switching temperatures of two comparators are defined with a fixed resistor network. In the pixel detector, the interlock signal ("POWER DISABLE") is set at 0.15 °C and reset ("POWER RE-ENABLE") at - 0.79 °C.

To simulate the behaviour of the final power supplies in the present tests, relays were put between the power supplies and the dummy modules Figure 5. The I-Box channels controlled these relays. Starting from stable

### 2.2) Direct PID control of Fluid Flow.

Direct PID control of circuit flow, on the basis of sensed exhaust temperature has proved an effective means of control. In a first study, a commercial PID controller<sup>10</sup> directly piloted the E2P driver. In a second study, a PID algorithm was implemented directly in a microcontroller chip<sup>11</sup> of the same family as that used<sup>12</sup> for system programming and monitor functions in the recently-developed "Embedded-LMB": [7], currently under test. In a third study, PID control was implemented using BridgeVIEW PID extension toolkit, using WAGO DAC modules to pilot the E2P drivers.

In each case, it was possible to maintain the temperature at a point ~50 cm downstream of the evaporation zone a significant margin (>10 °C) above the



# Condensation risk if vapour exhaust tube temperatures are below the local dew point(s)

## How to avoid this?

Deliver sufficient fluid to evacuate the heat from the Si modules (variable; function of n° of modules powered per stave,  $I_{\text{leak}}$  etc...) *but not too much (to avoid evaporation in ~ 25m tubing)!*

## One intelligent technique;

Feedback from temp. Sensors on exhaust tubing to flow regulators;

Done by Proportionnel, Intégrale & Dérivative *firmware* bloc;

$$p(t) = K_c [e(t) + (1/\tau_I) \int_0^t e(t^*) dt^* + \tau_D (de/dt)]$$

Object: maintain temperature downstream of evaporator a few °C above  $T_{\text{evap}}$  defined by the backpressure regulator downstream of 25m exhaust tubing:

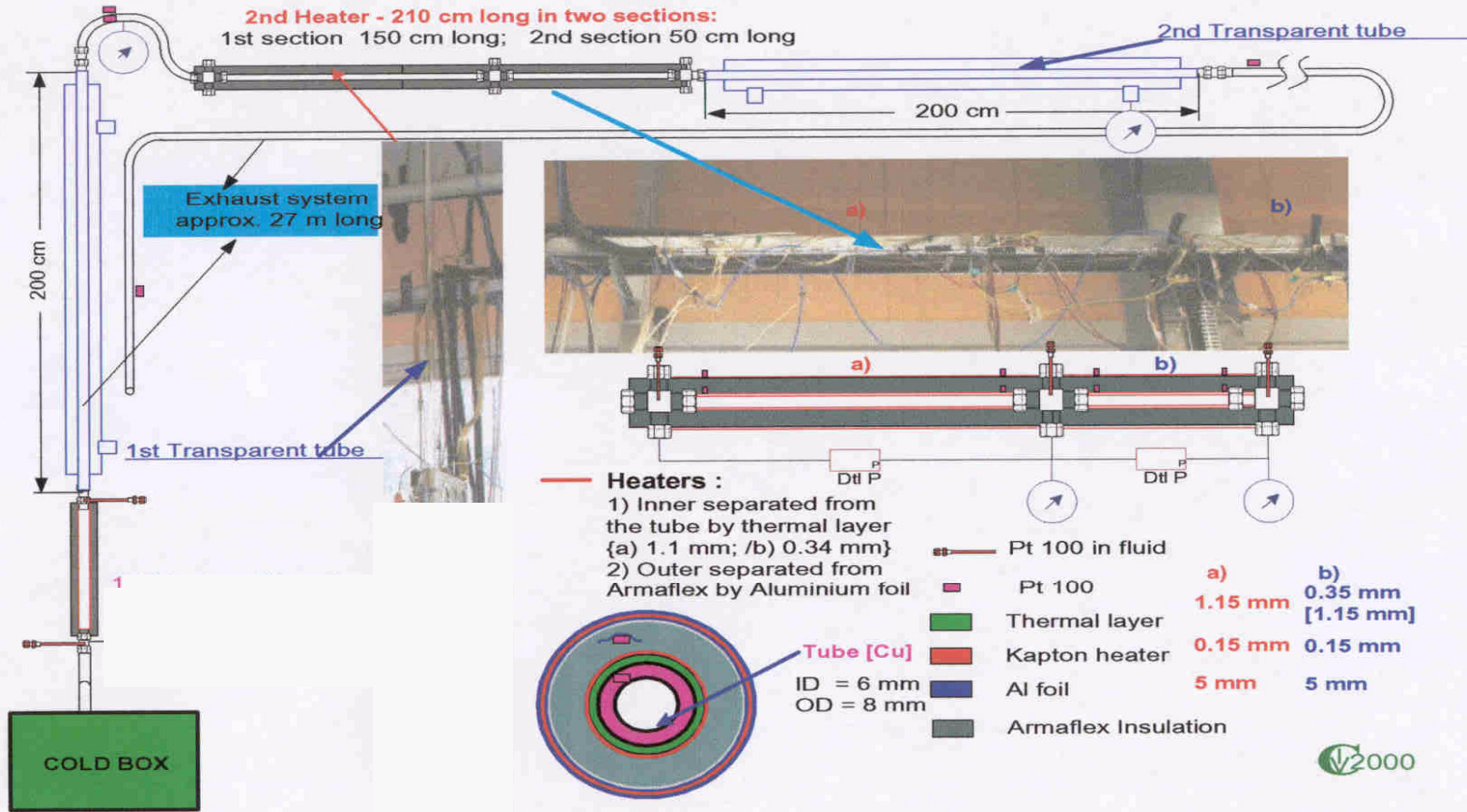
Thermistor or PT100 to E-LMB analog input

+ DAC output (0-10VDC) to flow regulator (coolant mas flow)

PID could have been easily added to E-LMB (sufficient memory in  $\mu$ controller)

# Evaporative Cooling System Exhaust Tube Studies verification of operation of proportional flow

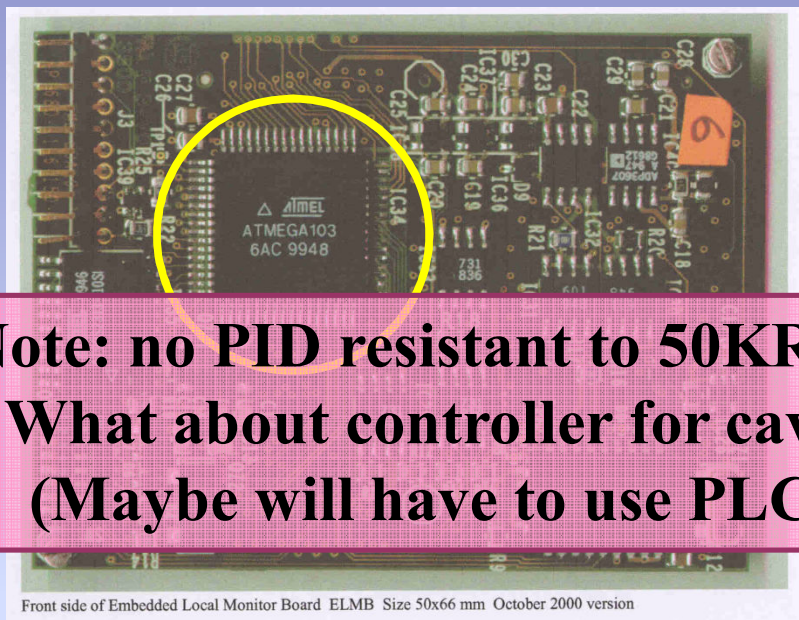
## Exhaust tube modification for the Cooling System set-up with Haug Compress







# ATLAS DCS E-Local Monitor Board



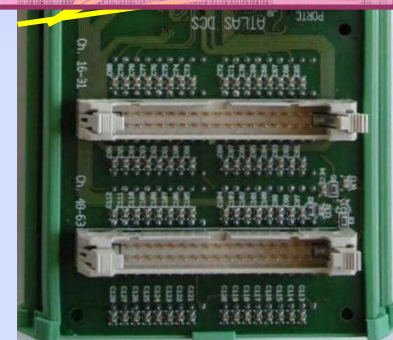
Sensor inputs

Sensor inputs

**Note: no PID resistant to 50KRad existed in commercial market  
What about controller for cavern rates at  $L \sim 10^{34}$  operation?  
(Maybe will have to use PLCPID or E-LMBs in USA15...)**

CAN  
Connectors for peripherals  
(e.g. DAC card)

- Node CAN bus (→32 on a bus)
- Resistant to 50KRad  
(10 yr/cavern ATLAS @ $10^{33}$ )
- 64 analog inputs (PT100 etc.)
- 32 bits DI/O
- 2Mo program space in  $\mu$ -controller



Sensor inputs

Sensor inputs

Carte mere



# ELMB PID-controller (framework)

*ELMB-based multiple PID-controller  
with CANopen interface*

*software user manual,  
version 0.1 (draft)*

20 May 2002

Henk Boterenbrood  
[boterenbrood@nikhef.nl](mailto:boterenbrood@nikhef.nl)



# ELMB-DAC 16-channel 12-bit DAC-module

*for the ELMB*

*user manual, version 0.0*

18 Feb 2002

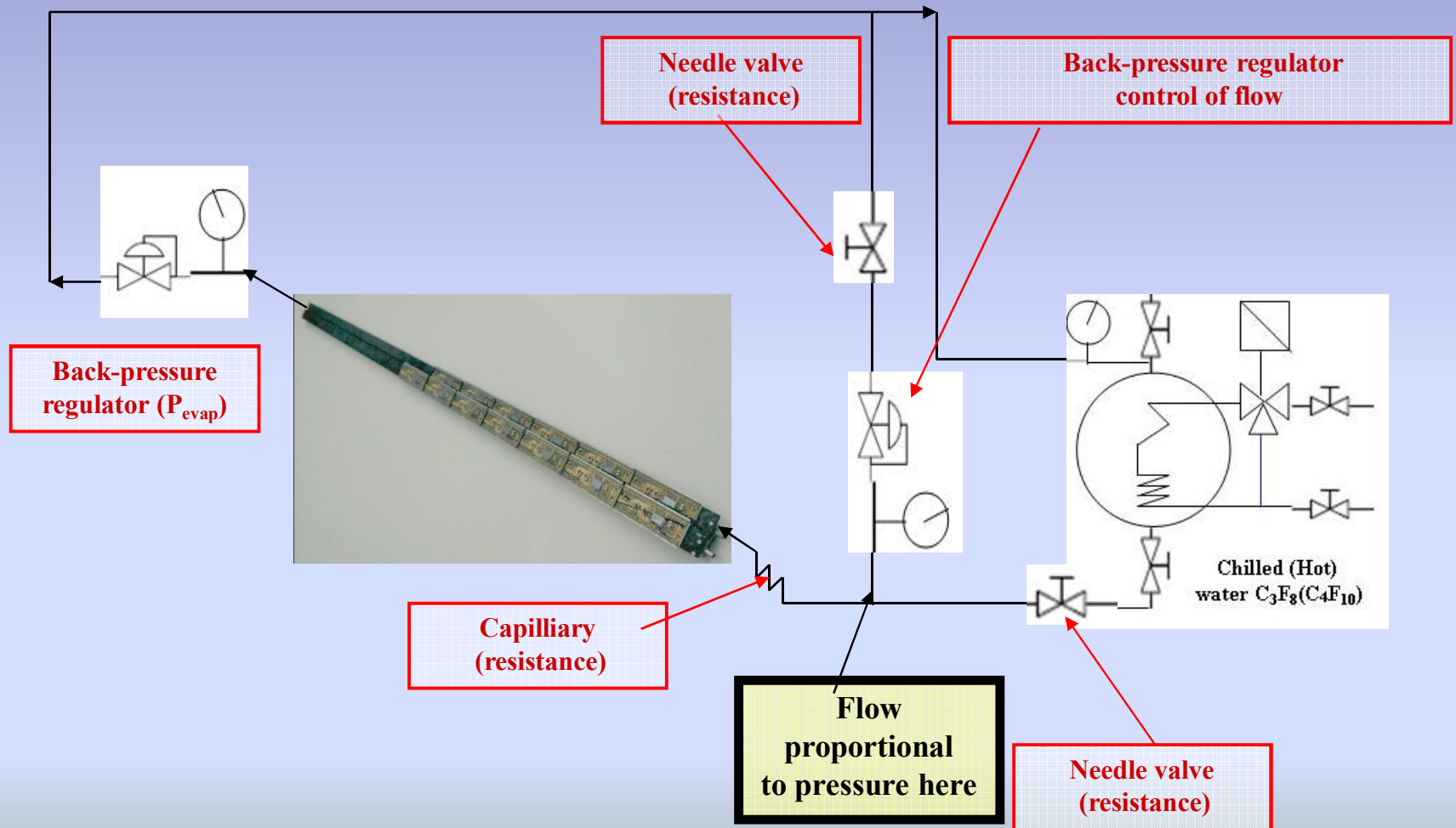
Jaap Kuijt, Piet de Groen, Paul Timmer,  
Daniel Tascon Lopez, Sander Schouten, Henk Boterenbrood



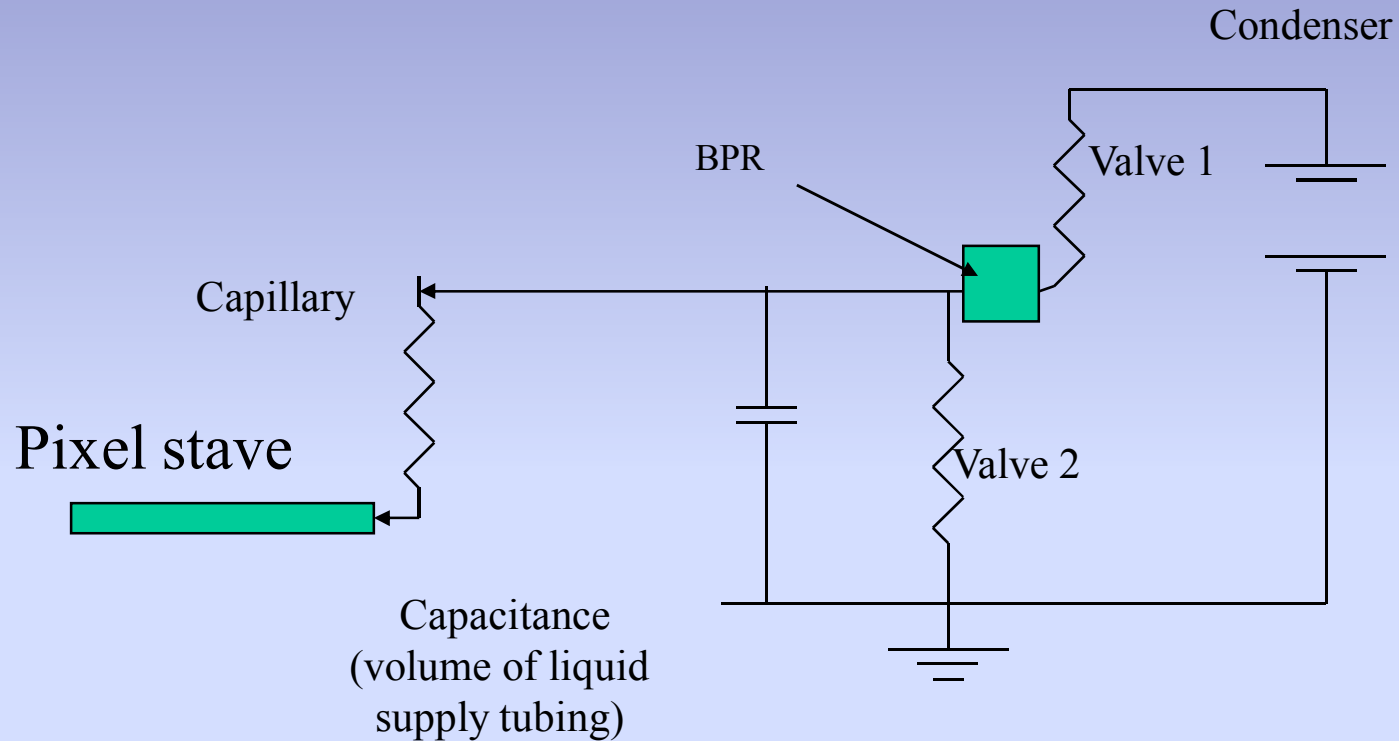
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# Rapid response pressure regulation (by backpressure regulator only) for variable thermal load on a pixel stove

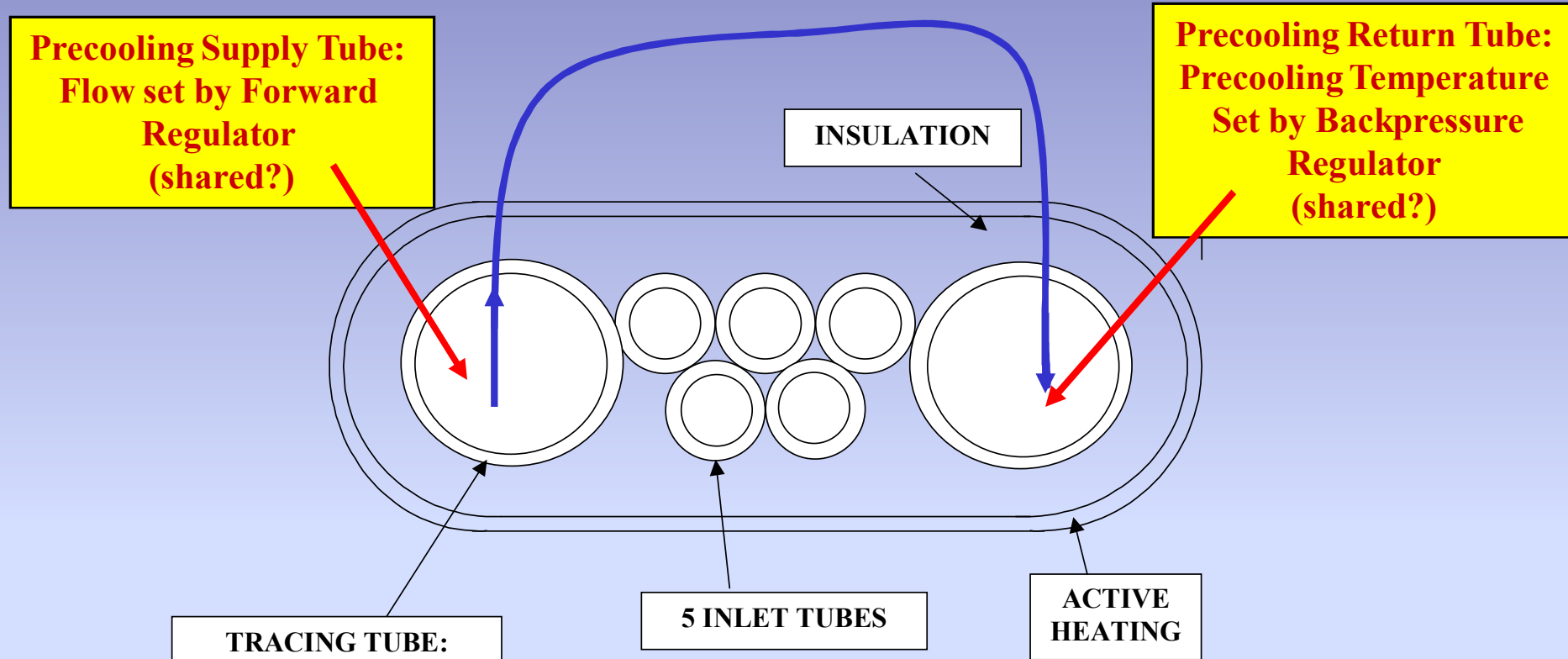


## Equivalent electric circuit



Rapid discharge of capacitance via parallel path  
(BPR+ valve 2)

# “Cold-Nosing” The Liquid Supply Tubes

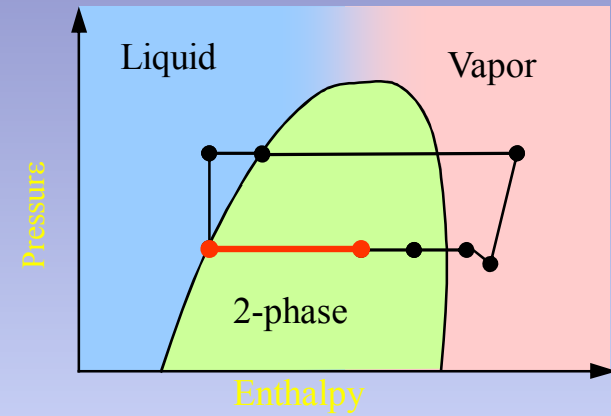
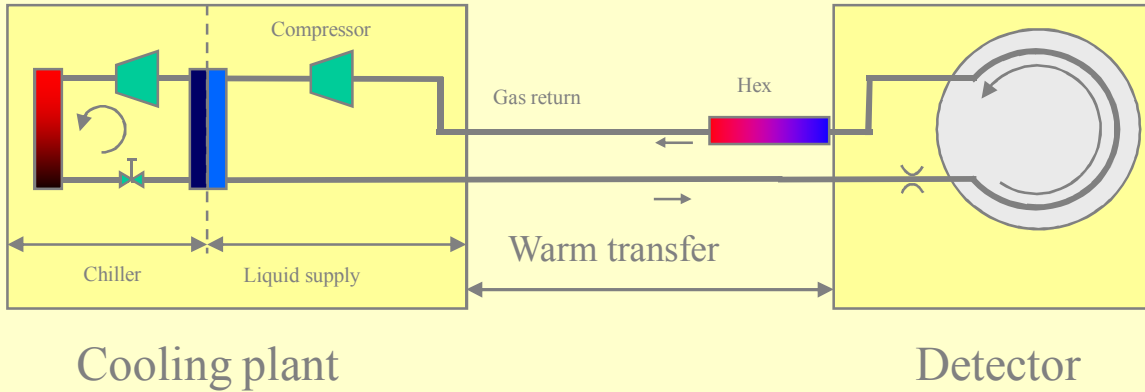


## Capillary Connection between Input and Output Pre-Cooling Tubes in Type 1 Service Area

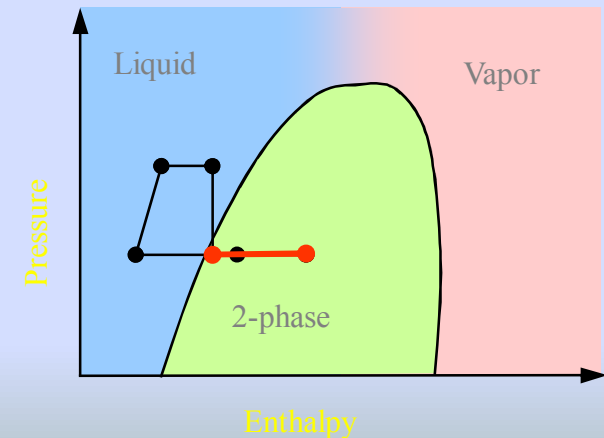
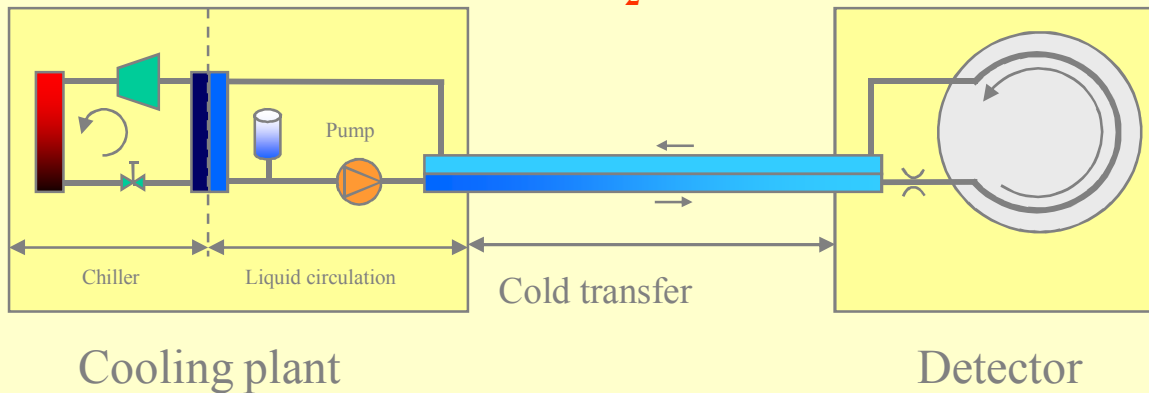
# CO<sub>2</sub> Closed cycle systems

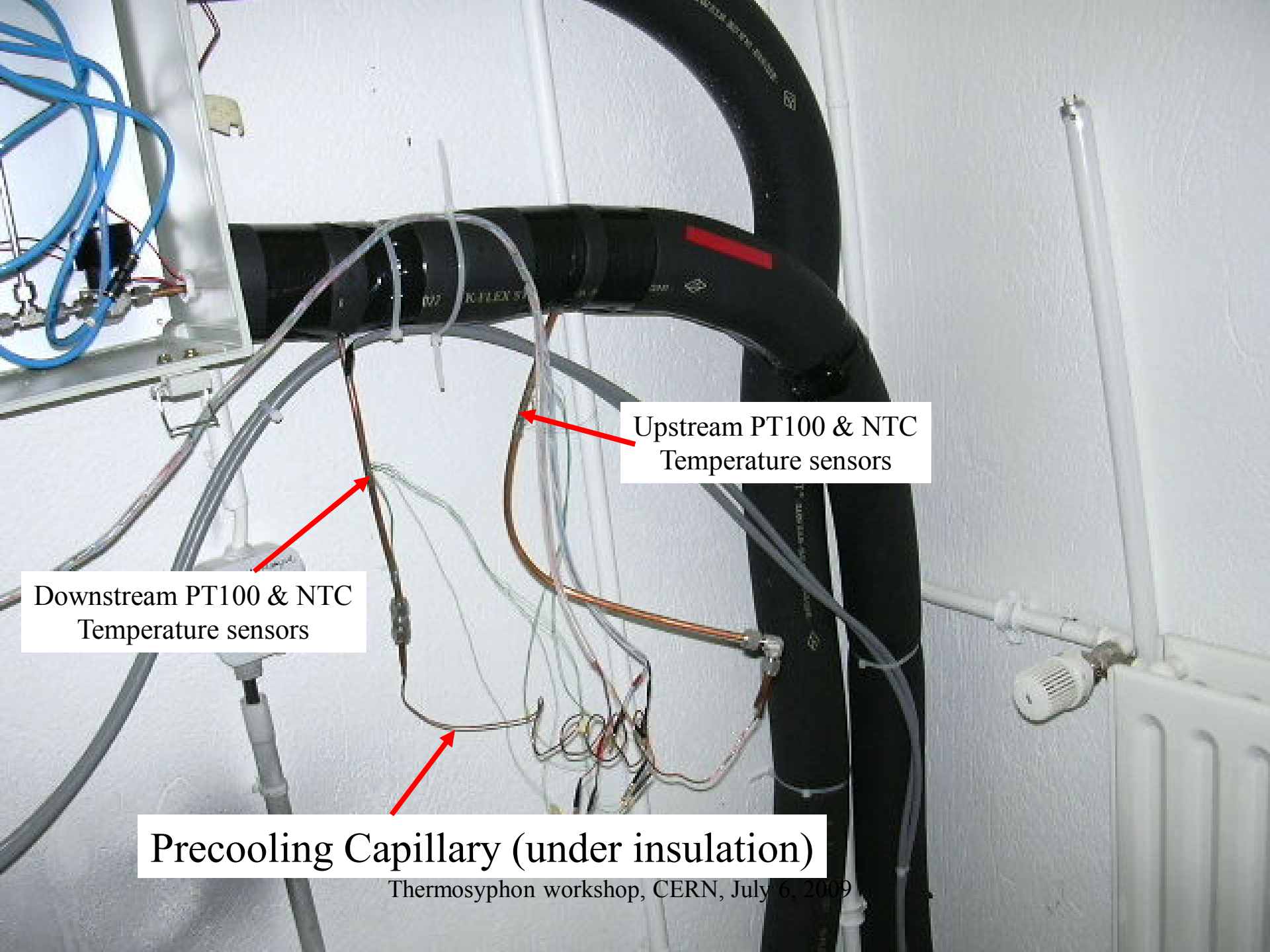
As in CO<sub>2</sub> refrigeration industry :

## Subcritical vapor-compression cycle



## LHCb-VELO: 2PACL pumped liquid system Fluid: CO<sub>2</sub>



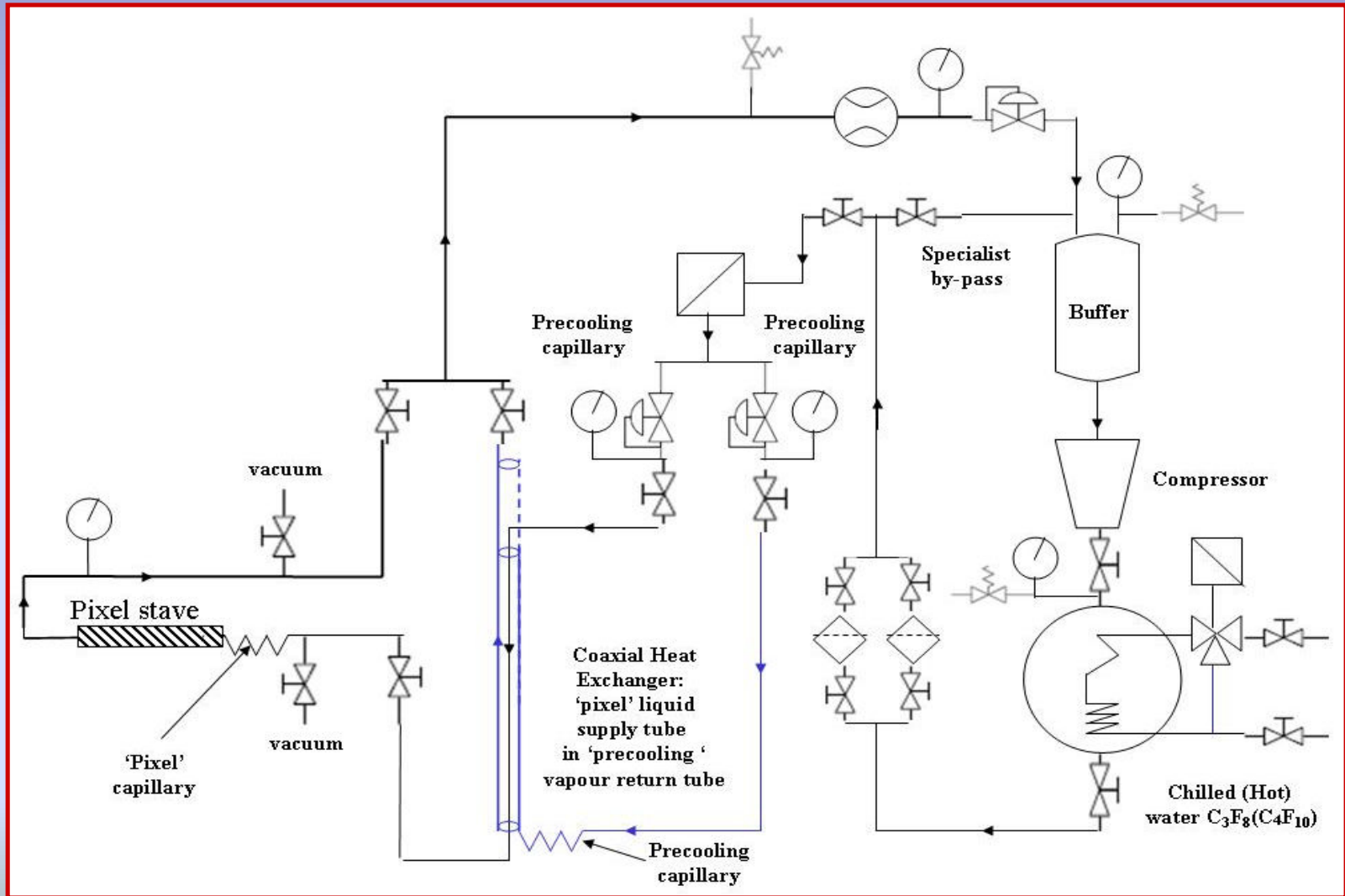


Upstream PT100 & NTC  
Temperature sensors

Downstream PT100 & NTC  
Temperature sensors

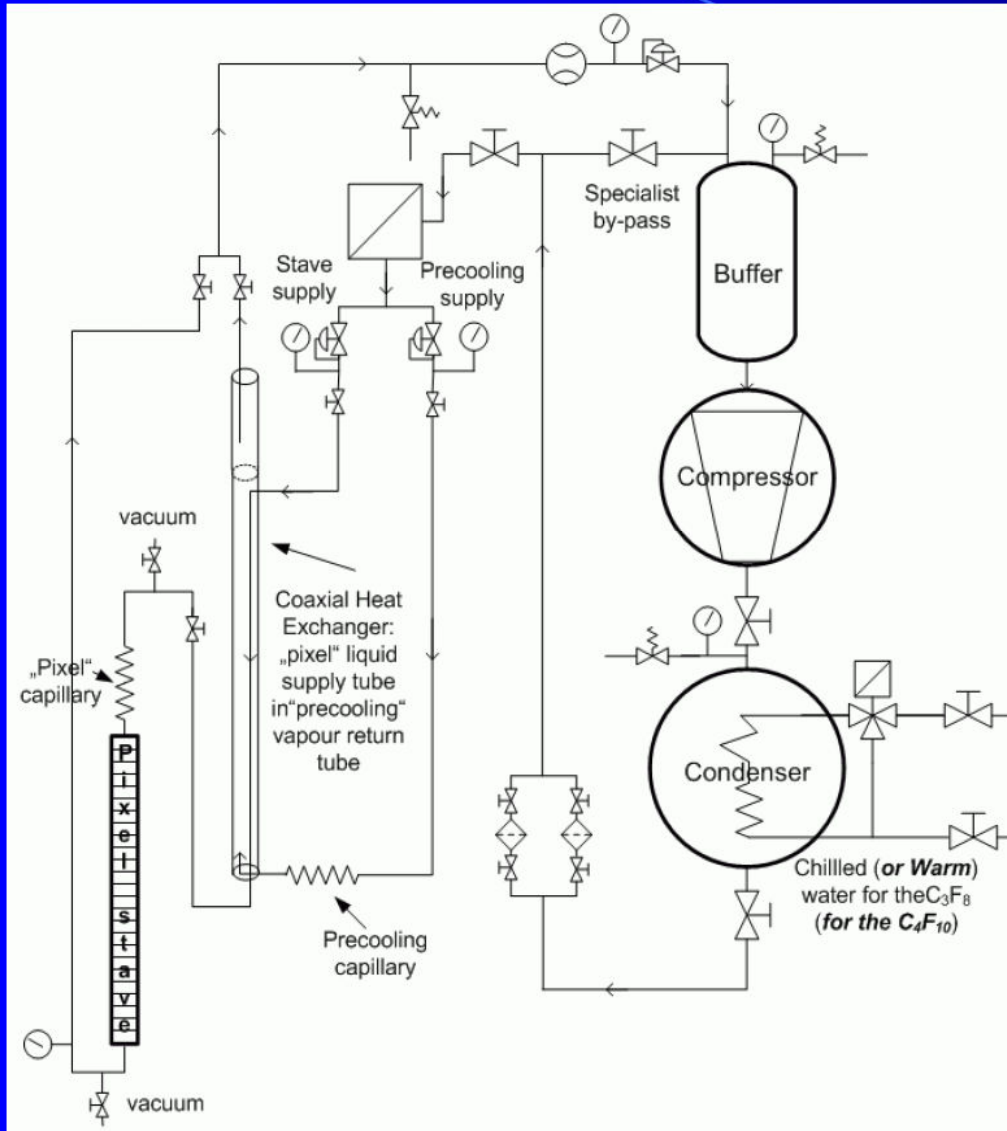
Precooling Capillary (under insulation)

# Systeme au CPPM pour qualification des échelles (“staves”) ATLAS Pixels





## Support studies - circulator for "dual-fuel", operation

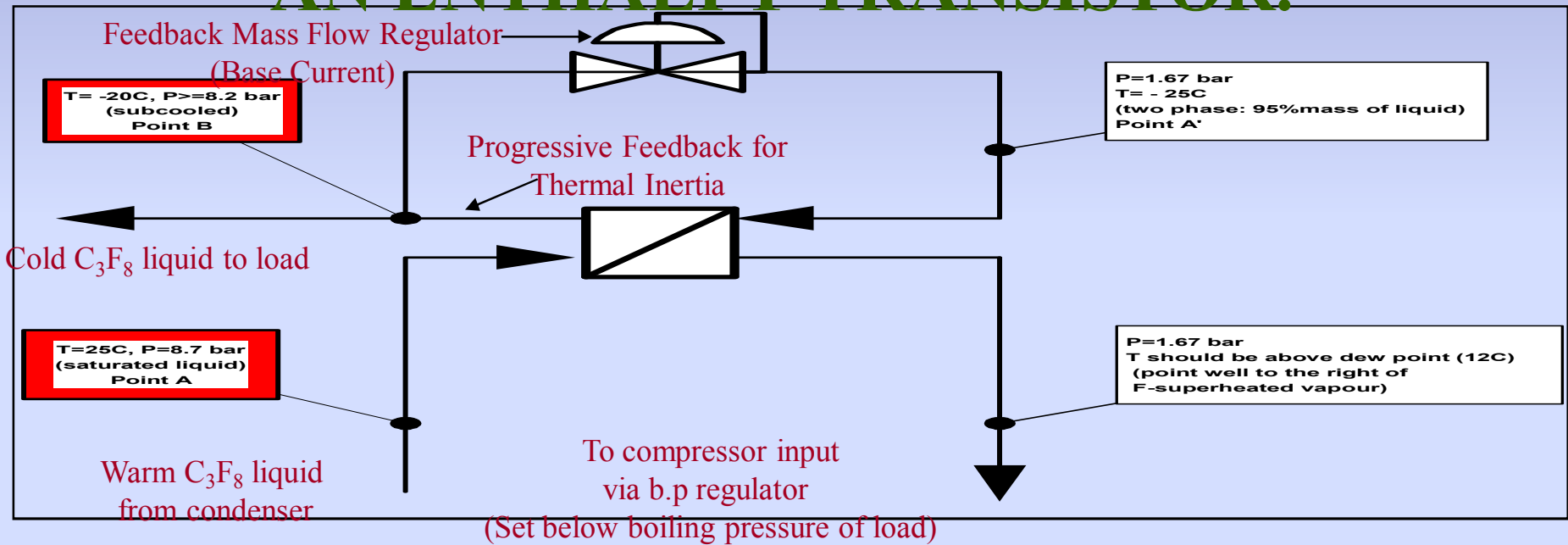


- Theoretical prediction of the fluid replacement had to be proven and verified experimentally
- Experimental setup at CPP Marseille has been used for the verification



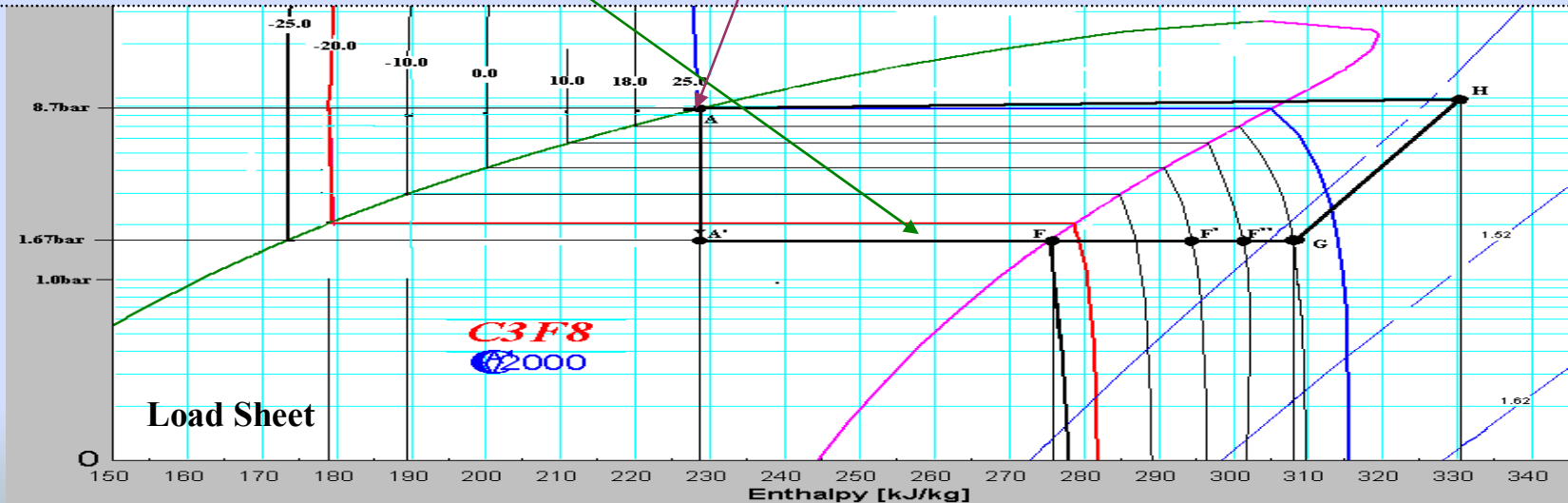
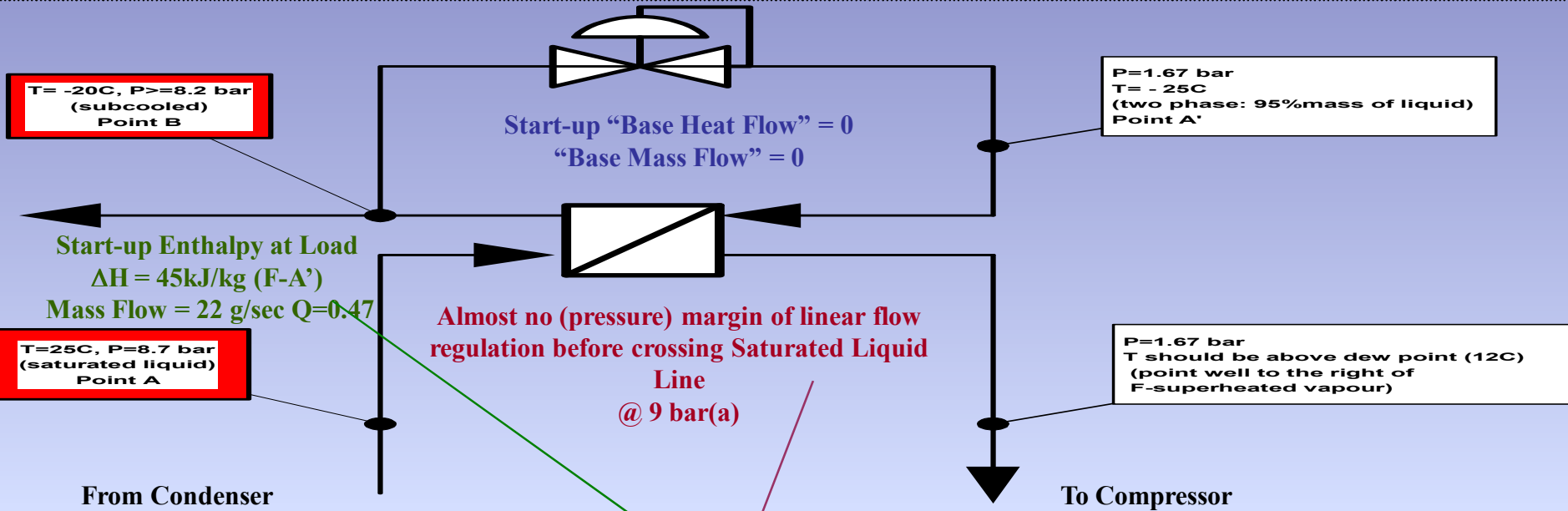
# Evaporative Cooling Demonstrator: Concept for Sub-cooling of $C_3F_8$ liquid with Counter-Evaporating $C_3F_8$ liquid in Heat Exchanger.

## AN ENTHALPY TRANSISTOR.



# HOW DOES IT WORK? (1)

## STARTUP (The case for 1 kW load cooling)



# HOW DOES IT WORK? (2)

## RUNNING (The case for 1 kW load cooling)

